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Four-dimensional dielectric property image obtained from electron spectroscopic imaging series

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Abstract
We have demonstrated a new quantitative method to characterize two-dimensional distributions of energy-dependent dielectric function of materials from low loss electron spectroscopic image (ESI) series. Two problems associated with extracted image-spectrum from the low-loss image series, under-sampling and loss of energy resolution, were overcome by using fast Fourier transformation (FFT) interpolation and maximum entropy deconvolution method. In this study, Black Diamond™/Si3N4/SiO2/Si-substrate dielectric layer designed for copper metallization was used as the sample. We show that the reconstructed (FFT interpolated and maximum entropy deconvoluted) image-spectrum obtained from ESI series images can be quantified with the same accuracy as conventional electron energy-loss spectroscopy spectra. Since the analysis of the dielectric function is sensitive to the local thickness of the specimen using Kramers–Kronig analysis, we also developed a new method to quantitatively determine the dielectric constant for low-k materials. We have determined the thickness of the Black Diamond using the extrapolated thickness method from the materials of known dielectric constants. Using Kramers–Kronig formula, the dielectric function map can be deduced from two-dimensional reconstructed single scattering spectra with providing the information of thickness. We proposed a four-dimensional data presentation for revealing the uniformity of the energy dependent property. The accuracy of our methods depends on the thickness determination and on the quality of the reconstructed spectra from the image series.

Keywords
dielectric property image, electron spectroscopic image series, FFT interpolation, maximum entropy deconvolution, image-spectrum, Kramers–Kronig analysis

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Introduction

Energy-filtered transmission electron microscopy (EFTEM) has become a very useful tool in characterizing material properties, because it allows the study of local chemical and electronic properties of a specimen at nanometre level spatial resolution [1–4]. Conventional EFTEM techniques utilize only two- or three-window methods to extract a two-dimensional elemental map [5,6] from inner-shell ionization edges occurring in electron energy-loss spectroscopy (EELS) spectrum.

The elemental map produced by the two- or three-window technique provides a rapid and efficient method for qualitative characterization. However, there is less study received for quantitative analysis with elemental maps. Basically, compositional quantitative analysis is commonly carried out by EELS spectrum. Two spectroscopic imaging methods have been established to obtain both the spatial and the spectral information, \( I(x, y, \Delta E) \), which can be quantitatively evaluated. One technique, known as the spectrum-image method, is
based on scanning the electron beam across the sample to acquire the EELS spectrum with two-dimensional information [7–9]. Conversely, the other method retrieves the spectra in a specific position from a series of energy loss images, and is known as the image-spectrum method [10–18]. The spectrum-image method can be achieved with better energy resolution, but requires a long acquisition time. Compared to the spectrum-image method, the advantage of the image-spectrum method is the capability of simultaneously recording abundant information in a series of maps. Nevertheless, besides plural scattering, there are still two main problems, under-sampling and loss of energy resolution, existing in the spectrum retrieved from the image-spectrum method. The problem of under-sampling is due to moving the energy slit in a discrete energy space, and loss of the energy resolution is due to finite width of energy slit in imaging filter.

Recently, the image-spectrum method has been proposed to evaluate compositional [12–18] and thickness distribution [12–15] quantitatively, with tens of images recorded across core loss edges and the low-loss region, respectively. Basically, the spectra extracted from a series of ESI images are broadened by both the width of the energy slit and the under-sampling, as the images were obtained with an energy slit of finite width, and were discretely sampled in the energy space. The energy resolution of the extracted spectrum from a series of ESI is reduced due to the integrated intensity within the energy slit used. The extracted spectrum is identical to the convolution of a perfect spectrum with a point spread function (PSF), which is a flat hat function with a width equivalent to that of the energy slit. A perfect spectrum can be recovered from a maximum entropy deconvolution [19] by using a PSF and a spectrum extracted from a series of ESI images. Maximum entropy and Fourier-log deconvolutions [1,2] are considered for different purposes. Maximum entropy deconvolution can remove noise and recover weak signal information due to the finite width of the energy slit, while the Fourier-log method is generally employed to remove the plural scattering effect [2]. Data must be well constructed to reconstruct reliably the spectrum since a maximum entropy deconvolution process requires sufficient sampling points to approach a smooth, continuous spectrum. Data interpolation is required not only to yield high accuracy in deconvolution and thus remove the effect of the finite width of the energy slit, but also to reduce the data acquisition and the amount of data storage. Normally, a linear, spline or polynomial function was employed for data interpolation. In previous work [12–18], linear interpolation was used to supplement the data in the energy space. The under-sampling may not be problematic when analyses are based only on integrating the area under the spectrum, and may not be sensitive to the methods of interpolation. However, under-sampling may be crucial for conducting dielectric function and energy band gap analyses in the low-loss region, and determining the fine structure in the core-loss region where energy resolution may significantly influence the data analysis. The fine structure in the core-loss region of EELS spectrum may have no simple relationship with the energy loss. Therefore, assuming a polynomial function to interpret data may lose physical meaning when the local fine structure in EELS spectrum is extracted. In this study, a fast Fourier transformation (FFT) interpolation [20] is used to solve the under-sampling in the image-spectrum. The merit of FFT interpolation over linear, polynomial or cubic spline methods, is that no relationship is assumed between the interpolated data and the original data points. FFT interpolation may be a good choice for universal interpolation in different ionization edges, since no mathematical model is employed. Moreover, in this paper, a constrained-maximum entropy method [21] originally designed to extend the spatial resolution for high-resolution image is now used to improve the energy resolution of the image-spectrum. The dielectric function, therefore, can be deduced from low-loss region of image-spectrum, with sufficient sampling and energy resolution with the regular Kramers–Kronig analyses [2]. Finally, we have proposed a four-dimensional data presentation to reveal the special two-dimensional distribution of the energy dependent dielectric function \([e_1 + ie_2, x, y, \Delta E]\), which is called the property image.

Because of the rapid development of low-dielectric constant (low-k) materials in copper metallization for semiconductor device [22], the determination of dielectric constant in low-k materials becomes very urgent. The dielectric constant can be determined from electrical measurements on metal-oxide-semiconductor (MOS) capacitors [23]. However, in patterning specimen, the conventional capacitance measurement is not feasible to determine the dielectric constant of low-k material.

In this paper, Black Diamond™ (BD) is used to test the accuracy of our analysis methods. Black Diamond is a silicon oxide-based low-k material, doped with a few percent of carbon and is designed by Applied Materials, USA, for the Cu metallization process. The mass density of BD (1.4 g cm\(^{-3}\)) indicates an estimate of porosity of 36% volume fraction of pores, with SiO\(_2\) (2.2 g cm\(^{-3}\)) as a reference. The dielectric constant of BD has been determined using capacitance measurement for reference [24].

**Experimental**

This study was performed with a JEOL 2010F transmission electron microscope operated at 200 kV and equipped with a Schottky type of field emission gun (FEG) and a Gatan imaging filter (GIF). Electron spectroscopic image series were recorded on a Gatan 1024 \(\times\) 1024 slow scan CCD-camera. The sample with structure of BD / Si\(_3\)N\(_4\) / SiO\(_2\) / Si-substrate was investigated. Black Diamond is a novel low-k dielectric material, designed for the Cu metallization process by Applied Materials Company [24]. The composition of BD is unknown. A wedge-shaped TEM sample was prepared by special tripod polishing method [25]. An image series consisting of seventy-one ESI images was recorded from –10 to 60 eV loss with steps of 1 eV. The width of the energy-selecting slit was also set to
be 1 eV. The exposure time of each image is 3 s. The collection semi-angle $\beta$ is 10 mrad. The experimental image series is shown in Fig. 1a. All the images are aligned with the cross-correlation technique. The theoretical spatial resolution of an ESI image was estimated by the method of Krivanek et al. [26]. In their study, three factors (delocalization, chromatic aberration, and aperture diffraction limit) are considered to limit the theoretical spatial resolution in ESI image. In the FEG TEM presented here, the energy spread of the electron beam was optimized to about 1 eV for regular application. In this work, the theoretical spatial resolution of ESI images was evaluated at approximately 15.2 and 1.9 nm for a plasmon energy loss of 5 and 50 eV, respectively.

As shown in Fig. 1a, each pixel within the image series can be treated as an individual EELS spectrum. The pixel resolution in the image is 0.94 nm per pixel. The image-spectra were extracted using the script language of Digital Micrograph software by integrating over $3 \times 3$ pixels in an area of $2.8 \times 2.8$ nm in the image. Figure 1b shows an extracted spectrum in BD from the image series. The dispersion (sampling energy step) of this extracted spectrum is 1 eV. The energy resolution in the extracted spectrum is lost due to the finite width of energy slit. As shown in Fig. 1b, the full-width at half-maximum (FWHM) of the zero-loss peak is roughly 1.6 eV.

Fig. 1 (a) Low-loss electron spectroscopic image series of BD / Si$_3$N$_4$/ SiO$_2$/ Si from -10 to 60 eV. (b) A spectrum extracted from the electron spectroscopic image series with sampling size of $3 \times 3$ pixels$^2$ in BD region.

Fig. 2 Flow chart of analytical method and algorithm.
The extracted spectra from the electron spectroscopic series images were reconstructed by FFT interpolation and deconvoluted by both maximum entropy and Fourier-log methods before quantitative analyses of dielectric function using Kramers–Kronig transformation. A flow chart of analytical procedures is demonstrated in Fig. 2. The details of the methodology and the algorithm are sequentially described in the next section. All the analysis programs are written in the script language of the Digital Micrograph software [27].

Methodology and algorithm

FFT interpolation

Interpolation by the FFT has become a practical proposition in many areas, such as image resampling, and digital signal processing (DSP) microcircuits [28]. The algorithm given here is basically modified from that suggested by Schafer and Rabiner [29]. Suppose that an extracted spectrum is denoted $S(E)$ which has $N$ pixels. $N$ is actually the number of electron spectroscopic images. The index $i$ is from 0 to $N - 1$. Fourier transform of this spectrum is given as $U(k)$.

$$U(k) = \frac{1}{N} \sum_{i=0}^{N-1} S(E_i) \exp\left(-\frac{2\pi ik}{N}\right),$$

where $k = -\frac{N}{2}, -\frac{N}{2} + 1, \ldots, 0, \ldots, \frac{N}{2} - 1 \quad (1)$

Let us create a new interpolated sequence $V(k)$, having $L = M \times N$ terms, where $M$ is an integer that we call resampling multiplier. A folding frequency or Nyquist limit $N_{eq}$ is the nearest rounding integer of $(N + 1) / 2$. The interpolation process basically involves folding the coefficients of $U(k)$ to both end of new sequence $V(k)$ and the zeros are added to the centre of $V(k)$. The $V(k)$ is given as

$$V(k) = \begin{cases} U(k) & k = -(L / 2), -(L / 2) + 1, \ldots, -(L / 2) + N_{eq} - 1 \\ 0.5 U(k) & k = -(L / 2) + N_{eq} (N \text{ even}) \\ U(k) & k = -(L / 2) + N_{eq} (N \text{ odd}) \\ 0 & k = -(L / 2) + N_{eq} + 1, \ldots, (L / 2) + N_{eq} + 1 - N \\ U(k) & k = (L / 2) + N_{eq} + 1 - N, \ldots, (L / 2) - 1 \end{cases} \quad (2)$$

Note that, if $N$ is even, all terms are carried over to the new sequence with equal weighting except the term at the folding frequency $k = -(L / 2) + N_{eq}$ which must be given a relative weighting of one half. If $N$ is odd, all terms have equal weighting. If the spectrum is a real function, then the $U(k)$ in the last frequency domain is conjugated related to that in the first frequency domain. The new interpolated spectrum $S'(AE)$ with $L$ pixels can be obtained by an inverse Fourier transform of $V(k)$. The originally extracted spectrum, presented in Fig. 1b, is interpolated to 0.125 eV dispersion by FFT interpolation. Figures 3a and 3b display two magnified spectra, to demonstrate the differences among the FFT, spline and linear interpolations in the energy region of zero loss and plasmon loss, respectively. The data from different interpolated methods are displayed separately to show clearly the differences among the data from each method of interpolation. The black squares indicate the original data of the extracted spectrum, and the circles, triangles and crosses represent FFT, spline and linear interpolated data, respectively.

Linear interpolation produces a relatively rugged spectrum, while the FFT and spline methods give a smooth curve. The artefacts usually occur in the maximum entropy deconvolution process in a rugged spectrum, since such a deconvolution tends to enhance the weak peak signal. FFT, spline or polynomial interpolations might not show great differences in further maximum entropy deconvolution and might not be critical in determining the dielectric function which was determined from Kramers–Kronig method by using the area under the curve of plasmon loss. However, in the core-loss region, the sharp ionization edge is not simply, mathematically related to the fine structure in the EELS spectrum (by polynomial, cubic, or any other relationship). Different ionization edges are associated with different relationships. Accordingly, FFT interpolation could be a good choice for universally interpolating for different ionization edges, since such an interpolation involves no mathematical model. The artefact from FFT interpolation may occur when the spectrum contains a large intensity difference. As shown in Fig. 3c, if the zero-loss peak and plasmon-loss peak are processed together, a small modulation may be induced in the lower intensity part, although this modulation is much smaller than the zero-loss peak. This small modulation can be removed either by separately processing the plasmon and zero-loss peak, or by a wavelet transformation.

Maximum entropy deconvolution method

Overwijk and Reefman have used the maximum entropy method to remove the instrumental response function of the zero-loss peak [19]. In this paper, we adopt a constrained maximum entropy method (MEM) [21,30], which was designed to extend spatial resolution of high resolution images in a NiSi2/Si interface, to improve the energy resolution suffered from the finite width of energy slit. Our method is slightly different from that of Overwijk and Reefman in the constraint terms coupling with the entropy. In our study, maximum entropy method is used to deconvolute the finite energy slit effect from a FFT interpolated spectrum. Deconvolution is carried out by minimization of a Lagrangian function $L$, providing a known point spread function $PSF(E_i)$ which is a flat hat function with a width equivalent to that of the energy slit.

$$L = -\sum_i S(E_i) \ln \left( \frac{S(E_i)}{D(E_i)} \right) - \lambda_1 \sum_i (S(E_i) - f)$$

$$-\lambda_1 \sum_i [S(E_i) \ast PSF(E_i) - S^{\text{exp}}] \quad (3)$$

$S(E_i)$ is an optimum spectrum which we would like to find and $E_i$ is a vector in the energy space. The $i$ is an index of $i$th pixel in the spectrum. The summation is carried out on all pixels and $S^{\text{exp}}$ is a spectrum after the FFT interpolation. The first
Fig. 3 FFT, spline and linear interpolation in (a) the energy region of zero loss, and (b) the energy region of plasmon loss of Fig. 1b. (c) The artefacts of FFT interpolation arise from the spectrum contain huge intensity difference.
term in Lagrangian function is the cross entropy, while the next two terms are the constraints for the optimum spectrum. The \( D(E_i) \) in the entropy term is a default guess that can be obtained by using a Wiener filter \([31]\). The \( \lambda_0 \) and \( \lambda_1 \) are two Lagrangian multipliers for two constraints. The first constraint sets the constant flux in the optimum solution \( S(E_i) \) and the second constraint sets the condition that the optimum \( S(E_i) \) convolutes with PSF\((E_i) \) should be as close to be the \( S_{opt} \) as possible. This maximum entropy deconvolution method has been extensively used in the area of astronomy and signal processing to enhance the resolution of images (or signals) \([32,33]\). An example of maximum entropy deconvolution is given in Fig. 4a. The solid line is a FFT interpolated spectrum of zero-loss peak in Fig. 1b reconstructed from the BD and the dashed line is the deconvoluted version of zero-loss peak. The FWHM of the FFT interpolated spectrum and the deconvoluted one are 1.6 and 1 eV, respectively. Apparently, the maximum entropy deconvolution improves the energy resolution of the EEL spectrum. The deconvoluted spectrum and an EELS spectrum acquired in image mode from BD are both shown in Fig. 4b. As we can see, reasonable agreement between these two spectra is obtained. The results indicate that the reconstructed spectrum from the ESI series images can be quantified with the almost same accuracy as the conventional EELS spectrum after FFT interpolation and maximum entropy deconvolution.

**Dielectric function analyses from Kramers–Kronig transformation and specimen thickness determination**

The low-loss region of an EELS spectrum can provide the information of the energy-dependent dielectric function, \( \varepsilon(E) = \varepsilon_1 + i \varepsilon_2 \) and also the direct band gap of materials \([34–36]\) with Kramers–Kronig analysis \([1,2]\). Figure 5a is the zero-loss image of the images series in Fig. 1a. A three-dimensional visualization of the EELS spectra, as shown in Fig. 5b, was established from 46 image-spectra which were reconstructed along a line from A to B. The Si substrate and the other three dielectric layers have different characteristic plasmon peaks with Si 16.3 eV, SiO\(_2\) 22.4 eV, Si\(_3\)N\(_2\) 20.7 eV and BD 22.1 eV, respectively. The double plasma peak exists in the Si region may be attributed to a plural scattering effect. Such plural scattering effect can easily be removed by using the Fourier-log deconvolution \([37]\).

The relationship between single-scattering spectrum \( S(E) \) and the energy-loss function \( \text{Im}[-1 / \varepsilon(E)] \) is given as

\[
S(E) = - \frac{l_0}{\pi a_0 m_0 v^2} \cdot \text{Im}\left[ \frac{-1}{\epsilon(E)} \right] \cdot \ln\left[ 1 + \frac{E}{0_e} \right] \tag{4}
\]

where \( l_0 \) is the zero-loss intensity, \( t \) the specimen thickness, \( a_0 \) the first Bohr radius, \( m_0 \) the electron mass, \( \beta \) the collection semi-angle, and \( 0_e = E / (\eta m_0 v^2) \) the characteristic scattering angle for an energy loss \( E \). The real part of the dielectric function is related to the imaginary part by the Kramers–Kronig transformation \([38]\)

\[
\text{Re}\left[ \frac{1}{\epsilon(E)} \right] = 1 - \frac{2}{\pi} P \int_0^\infty \text{Im}\left[ \frac{-1}{\epsilon(E')} \right] \frac{E' \, dE'}{E' - E^2} \tag{5}
\]
where \( I_i \) and \( I_0 \) are integrals of the entire spectrum and of the zero-loss peak, respectively. \( \lambda \) is the inelastic mean free path, which is given as

\[
\lambda (\text{nm}) = \frac{106F(E_w/E_m)}{\ln(2\beta E_0/E_m)}
\]  

(6)

where

\[
E_m \approx 7.6z_{\text{eff}}^{0.36}, \quad Z_{\text{eff}} = \frac{\sum f_i Z_i^{1.3}}{\sum f_i Z_i^{0.3}}
\]

\[
F = \frac{1 + E_w/1022}{(1 + E_w/511)^2}
\]  

(7)

(8)

\( E_w \) is an average electron energy-loss in eV, \( Z \) is the atomic number, \( Z_{\text{eff}} \) is the effective atomic number of the specimen, \( f_i \) is the atomic fraction of the element of atomic number \( i \), and \( F \) is the relativistic factor.

Equations (7) and (8) are empirical equations that may not give good estimation in thickness for BD. Furthermore, the application of the log-ratio method to BD has difficulty, since the \( Z_{\text{eff}} \) and \( E_m \) for BD are unknown in our sample. Besides, Malis et al. [39] and Yang and Egerton [40] have discussed that the accuracy in specimen thickness determination using the log-ratio method is about 15% accuracy. This implies that the accuracy in determination of the dielectric function will be not better than 15%. In fact, we have found that the dielectric function analysis is very sensitive to the thickness and sometimes gives an error larger than in the thickness.

In our experiment, absolute thickness of BD is obtained from an extrapolated thickness of Si / SiO\(_2\) / Si\(_3\)N\(_4\). The thicknesses of these three regions are determined from the low-loss spectrum using Kramers–Kronig sum rule [41], providing that we know the refractive index \( n \) of these materials and that they are double checked using empirical eqs (7) and (8). The relationship of the thickness and \( n \) is given as

\[
t = \frac{2dE_0}{I_0(1 - \Re \frac{1}{\varepsilon(0)})} \int \varepsilon(E) dE
\]

(9)

where, \( \Re \frac{1}{\varepsilon(0)} = \frac{1}{n^2} \) and \( n \) is the refractive index of material.

The dielectric constant \( \varepsilon(0) \) of a dielectric material (insulator) is the square of the refractive index. The dielectric constants are for Si, 11.36, for SiO\(_2\) 3.8, and for Si\(_3\)N\(_4\) 3.6 [42]. The thickness of Si, SiO\(_2\), and Si\(_3\)N\(_4\) can be determined from the \( S(E) \) of reconstructed spectra, using eq. (9) with a known dielectric constant. Figure 6a is a \( t/\lambda \) map obtained from the electron spectroscopic series images in Fig. 1a using eq. (6), while the profile \( t/\lambda \) from the position A to C is given in Fig. 6b. A thickness profile along A to C (Si to Si\(_3\)N\(_4\)) obtained using eq. (9) is shown in Fig. 6c, which has the same trend as that of \( t/\lambda \) profile. Plitzko and Mayer [12–14] have also shown the same kind of humps in the interface, and a similar thickness variation across the interface in the thickness map. We suspect that the humps in the thickness profile of the interface, between dissimilar materials, may arise from the focus shift due to different energy losses. Furthermore, the deviation of the thickness profile from the straight line may be partially caused by the elastic scattering contrast, or the different milling rates in different layers.

The average thickness profile suggests that the sample has a wedge shape. The accuracy of thickness determination can be improved and estimated by averaging as many profiles as possible. The thickness profile is fitted to a linear equation, \( Y = \)
The thickness in BD region can be determined by extrapolating the thickness profile to the BD region. The λ profile shown in Fig. 6d can be determined from Figs 6b and 6c. The value of λ approximates to a constant value in each material region and this might give an indication that the thickness profile in Fig. 6c is reasonably good. The λ values calculated using eq. (7) are marked as squares in Fig. 6d. The average values of λ of Si, SiO2 and Si3N4 determined from ESI series and the calculated data using eq. (7) are given in Table 1.

The extrapolated thickness of the BD from C to D varies roughly from 70 to 20 nm. The maps of the dielectric functions (ε1 and ε2) of BD/Si3N4/SiO2/Si can then be determined using eqs (4) and (5) by providing information from the thickness map. Such information is obtained from the t/λ map in Fig. 6a using λexp in the right hand column of Table 1. Figure 7 presents a dielectric constant map of the multilayer BD/Si3N4/SiO2/Si. The dielectric constant is a value that corresponds to the real part of dielectric function at zero energy loss. The image in the left-hand side of Fig. 7 is a part of zero-loss image.
Table 1 Values of mean free path. The calculated values are obtained using eq. (7). The experimental values are averaged from / / / / profiles, Fig. 6b, and the thickness profile, Fig. 6c.

<table>
<thead>
<tr>
<th>Materials</th>
<th>λ_{cal} (nm)</th>
<th>λ_{exp} (nm)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Si</td>
<td>125.33</td>
<td>151.86 ± 3.68</td>
</tr>
<tr>
<td>SiO_{2}</td>
<td>137.40</td>
<td>129.47 ± 4.91</td>
</tr>
<tr>
<td>Si_{3}N_{4}</td>
<td>135.15</td>
<td>152.87 ± 7.93</td>
</tr>
<tr>
<td>Black Diamond™</td>
<td>None</td>
<td>127.01 ± 4.91</td>
</tr>
</tbody>
</table>

and the central image is the dielectric constant map of the same area. The average value of the dielectric constants of Si, SiO_{2}, Si_{3}N_{4} and BD are calculated by summing the values in dielectric constant map and dividing the number of pixels in the corresponding materials region. The average dielectric constant of BD is 2.69 ± 0.27, which is in good agreement with reference value (2.5 – 2.8) measured using the capacitance method [22]. The comparison between dielectric constant of four materials and reference data are given in Table 2. The average values of the dielectric constant for these four materials are 11.02 ± 0.47, 4.20 ± 0.31, 3.69 ± 0.30, and 2.69 ± 0.27, respectively, which are very close to their reference values 11.36, 3.8, 3.6 and 2.5 – 2.8 [42].

Turowski and Kelly used a field-emission STEM to record low-loss spectra as a function of position, across an Al / SiO_{2} / Si field-effect transistor structure [43]. The authors showed the dielectric function across Al / SiO_{2} / Si heterostructures; however, the line profile of dielectric function contained only one-dimensional spatial information. We propose that a four-dimensional property image presentation, which allows the uniformity of the energy dependent dielectric function, can be revealed in two dimensions. The four-dimensional dielectric property images of ε_{1} and ε_{2} are given in Fig. 8. The four dimensions refer to space (x, y), electron energy-loss (eV) and the dielectric function (ε(E)). Since there are abundant data in four dimensions, we present the property images only from a small portion of image and with 0.5 eV dispersion. The most left-hand side images in Figs 8a and 8b are a small portion of zero-loss image and the central parts are the real (ε_{1}) and imaginary part (ε_{2}) of dielectric property image, respectively.

Concluding remarks

We have developed FFT interpolation and maximum entropy deconvolution methods to overcome two problems, un-
sampling and loss of energy resolution, in electron spectroscopic imaging series for quantitative analysis of dielectric function. Reconstructed spectra have shown the same resolution as that acquired with a focus beam. Since the analysis of the dielectric function is sensitive to the local thickness of the specimen, we have determined the thickness of the BD using extrapolated thickness method from the materials of known dielectric constants. The dielectric function map can be

Fig. 8 The dielectric property images. (a) The real part \( \varepsilon_1 \) and (b) imaginary part \( \varepsilon_2 \) of dielectric function. The most left-hand side images in (a) and (b) are a small portion of zero-loss image. The energy dispersion is 0.5 eV for both (a) and (b).
deduced from two-dimensional reconstructed single-scattering spectra and the thickness using Kramers–Kronig analysis. We proposed a four-dimensional data presentation for revealing the uniformity of the energy dependent property. The accuracy of our methods depends on the thickness determination and the quality of the reconstructed spectra from the image series.

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